



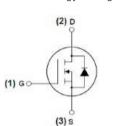
MJ N-Channel Enhancement Mode Power MOSFET

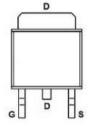
Description

The MJ3050K uses advanced trench technology and design to provide excellent $R_{\text{DS(ON)}}$ with low gate charge. It can be used in a wide variety of applications.

General Features

- ♦ V_{DS} =30V,I_D =50A R_{DS(ON)} <11mΩ @ V_{GS}=10V (Typ:8mΩ) R_{DS(ON)} <16mΩ @ V_{GS}=5V (Typ:10mΩ)
- ◆ High density cell design for ultra low Rdson
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high EAs
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability



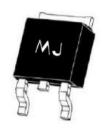


Application

Power switching application

Uninterruptible power supply

Hard switched and high frequency circuits



Schematic diagram

Marking and pin Assignment

TO-252-2L top view

100% UIS TESTED! 100% ΔVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
MJ3050K	MJ3050K	TO-252-2L	2	=	2

Absolute Maximum Ratings (Tc =25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	30	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	lp	50	Α
Drain Current-Continuous(Tc =100℃)	ID(100°C)	35.4	А
Pulsed Drain Current	Ідм	200	А
Maximum Power Dissipation	PD	60	W
Derating factor		0.4	W/°C
Single pulse avalanche energy (Note 5)	Eas	100	mJ
Operating Junction and Storage Temperature Range	Tл,Tsтg	-55 To 175	°C

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	Rөjc	2.5	°C/W
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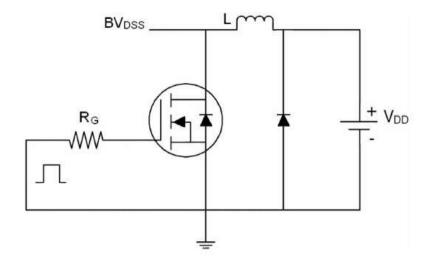
Electrical Characteristics (Tc =25°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BVDSS	V _{GS} =0V I _D =250µA	30	33	-	V
Zero Gate Voltage Drain Current	loss	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	lgss	V _{DS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>		II.			
Gate Threshold Voltage	VGS(th)	V _{DS} =V _{GS} ,I _D =250µA	1	1.6	2.6	V
	_	V _{GS} =10V, I _D =20A	-	8	11	mΩ
Drain-Source On-State Resistance	Rds(on)	V _{GS} =4.5V, I _D =20A	-	10	16	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =20A	-	20	-	S
Dynamic Characteristics (Note 4)						
Input Capacitance	Clss		-	2000	-	PF
Output Capacitance	Coss	V _{DS} =15V,V _{GS} =0V F=1.0MHz	-	280	-	PF
Reverse Transfer Capacitance	Crss	-	-	210	-	PF
Switching Characteristics (Note 4)	1					
Turn-on Delay Time	t _{d(on)}		-	10	-	nS
Turn-on Rise Time	tr	V _{DD} =15V,I _D =20A	-	8	-	nS
Turn-Off Delay Time	t _{d(off)}	Vgs=10V,Rgen=1.8Ω	-	25	-	nS
Turn-Off Fall Time	tr	-	-	5	-	nS
Total Gate Charge	Qg		_	32.3	-	nC
Gate-Source Charge	Qgs	V _{DS} =10V,I _D =20A V _{GS} =10V	-	4.9	-	nC
Gate-Drain Charge	Qgd	-	_	6.9	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	VsD	V _{GS} =0V,I _S =20A	-	0.85	1.2	V
Diode Forward Current (Note 2)	ls		-	-	50	А
Reverse Recovery Time	trr	T1-25°C 15-20^	-	_	27	nS
Reverse Recovery Charge	Qrr	TJ=25°C, IF=20A di/dt=100A/µs (Note 3)	_	-	20	nC
Forward Turn-On Time	ton	Intrinsic turn-on time is no	ealiaible(tı	ırn-on is d	ominated h	V S+ F

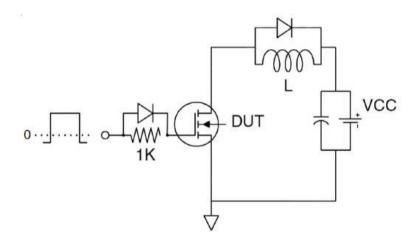
Notes:

- ① Repetitive Rating: Pulse width limited by maximum junction temperature.
- ② Surface Mounted on FR4 Board, t ≤ 10 sec.
- ③ Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- (4) Guaranteed by design, not subject to production
- \bigcirc EAS condition: Tj=25°C,VoD=15V,Vo=10V,L=0.5mH,Rg=25 Ω

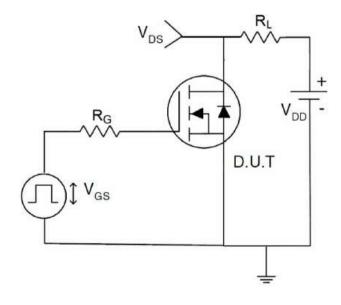
Test circuit



Eas test Circuit



Gate charge test Circuit

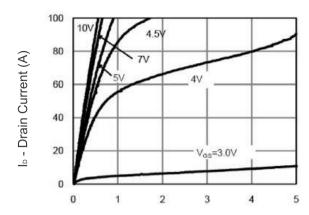


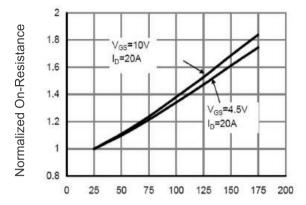
Switch Time Test Circuit



lo - Drain Current (A)

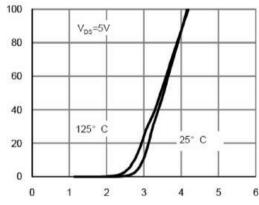
Rdson On-Resistance Normalized



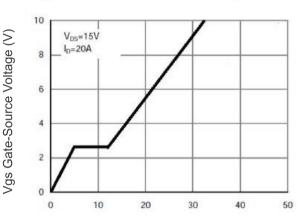


Vds Drain-Source Voltage (V)

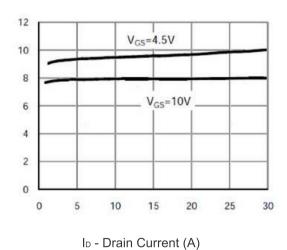
Figure 1 Output Characteristics



TJ -Junction Temperature(°C)
Figure 4 Rdson-Junction Temperature



Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics



Qg Gate Charge (nC)
Figure 5 Gate Charge

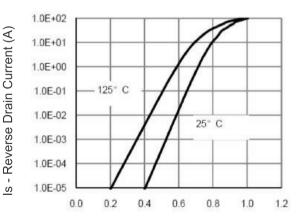
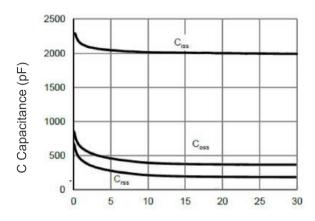


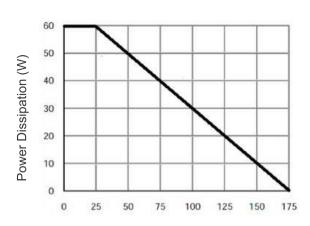
Figure 3 Rdson- Drain Current

Vsd Source-Drain Voltage (V)
Figure 6 Source- Drain Diode Forward

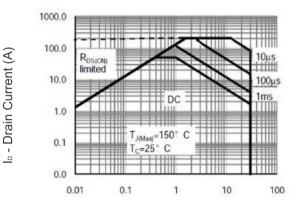




Vds Drain-Source Voltage (V)
Figure 7 Capacitance vs Vds

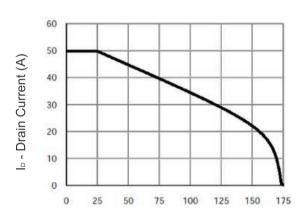


T_J -Junction Temperature(°C)
Figure 9 Power De-rating



Vds Drain-Source Voltage (V)
Figure 8 Safe Operation Area

r(t), Normalized Effective



TJ -Junction Temperature(°C)
Figure 10 Ib Current- Junction Temperature

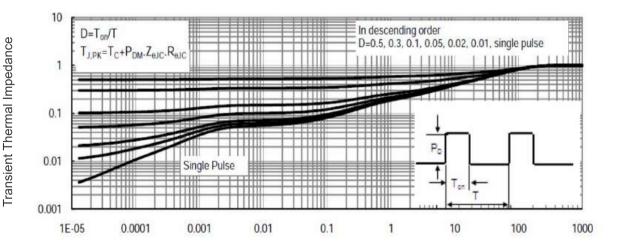
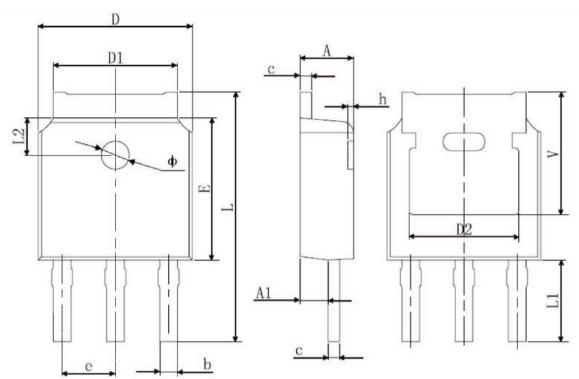


Figure 11 Normalized Maximum Transient Thermal Impedance





TO-251S Package Information



O	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.860	1.160	0.034	0.046	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	4.830	REF.	0.190 REF.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	10.400	11.000	0.409	0.433	
L1	3.300	3.700	0.130	0.146	
L2	1.600 REF.		0.063	REF.	
Ф	1.100	1.300	0.043	0.051	
h	0.000	0.300	0.000	0.012	
V	5.350 REF.		0.211	REF.	





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